



Ultra Low Profile Halogen Free 0404 Balun 50Ωto 50ΩBalanced

Description:



The B4859N5050AHF is a low cost, low profile sub-miniature unbalanced to balanced transformer designed for differential inputs and output locations on modern chipsets in an easy to use surface mount package covering 802.11a Uni-Band II & III and the Japanese ISM band (4.9 GHz). The B4859N5050AHF is ideal for high volume manufacturing and delivers higher performance than traditional ceramic baluns. The B4859N5050AHF has an unbalanced port impedance of 50Ω and a 50Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The B4859N5050AHF is available on tape and reel for pick and place high volume manufacturing.

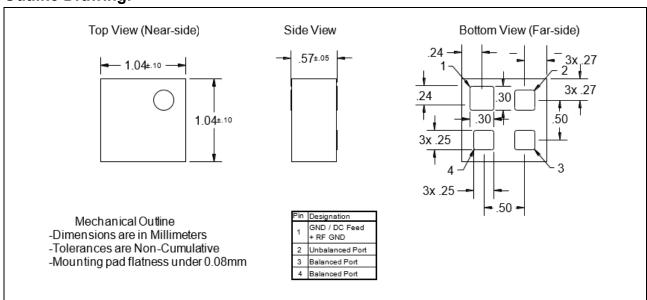
Detailed Electrical Specifications:

Specifications subject to change without notice

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<u>Features:</u>		ROOM (25°C)			
• 4800 – 5900 MHz	Parameter	Min.	Тур.	Max	Unit
0.57 mm Height Profile	Frequency	4800		5900	MHz
• 50 Ohm to 2 x 25 Ohm	Unbalanced Port Impedance		50		Ω
 Low Insertion Loss 	Balanced Port Impedance		50		Ω
 802.11a Uni-Band II & III 	Return Loss	13	20		dB
 Home Cordless Compliant 	Insertion Loss*		0.5	0.7	dB
Surface Mountable	Amplitude Balance		0.7	1.2	dB
Tape & Reel	Phase Balance		3	7	Degrees
Non-conductive Surface	CMRR		27		dB
RoHS Compliant	Power Handling @85C			1.0	Watts
Halogen Free	Power Handling @105C			0.6	Watts
- 1141090111100	Operating Temperature	-55		+105	°C

^{*} Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

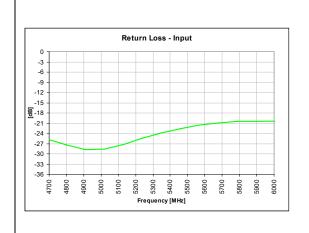
Outline Drawing:



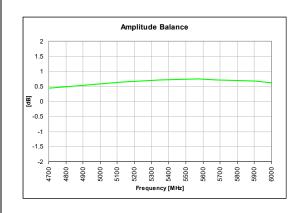




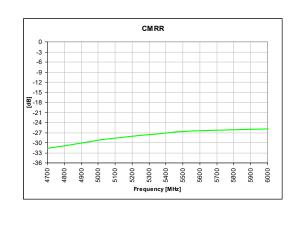
Typical Performance: 4700 MHz. to 6000 MHz.







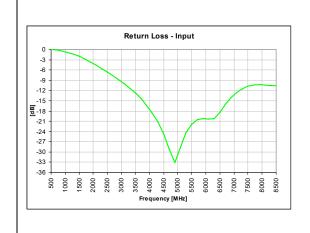


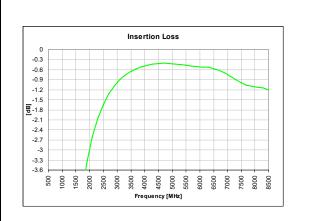


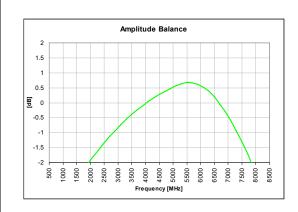


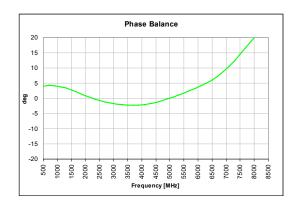
Model BD4859N5050AHF

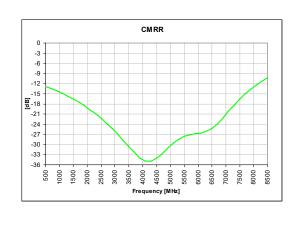
Wide Band Performance: 500 MHz. to 8500 MHz.













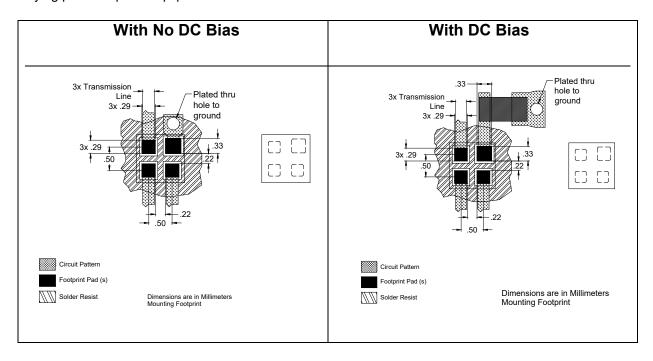


Mounting Configuration:

In order for Xinger surface mount components to work optimally, the proper impedance transmission lines must be used to connect to the RF ports. If this condition is not satisfied, insertion loss, Isolation and VSWR may not meet published specifications.

All of the Xinger components are constructed from organic PTFE based composites which possess excellent electrical and mechanical stability. Xinger components are compliant to a variety of ROHS and Green standards and ready for Pb-free soldering processes. Pads are Gold plated with a Nickel barrier.

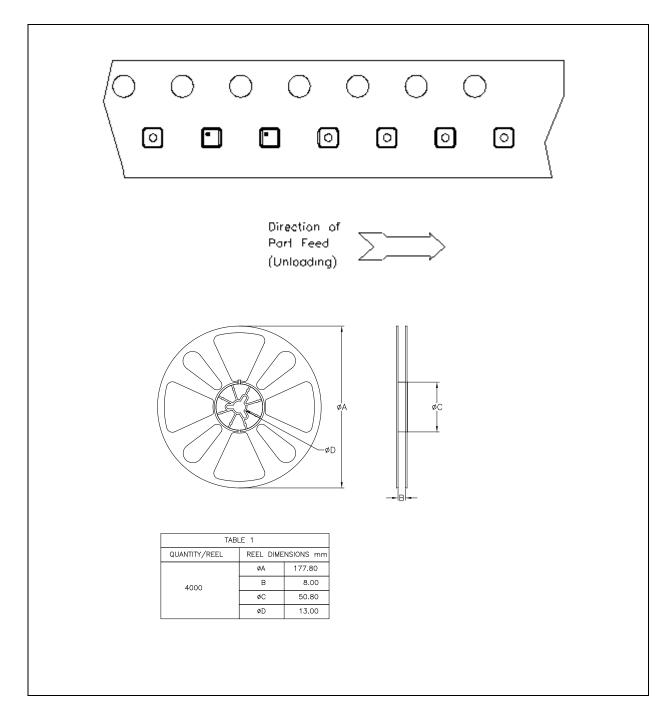
An example of the PCB footprint used in the testing of these parts is shown below. In specific designs, the transmission line widths need to be adjusted to the unique dielectric coefficients and thicknesses as well as varying pick and place equipment tolerances.





Packaging and Ordering Information:

Parts are available in reel and are packaged per EIA 481-D. Parts are oriented in tape and reel as shown below. Minimum order quantities are 4000 per reel.



Contact us:

rf&s support@ttm.com



Mouser Electronics

Authorized Distributor

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